

RoHS

COMPLIANT

LNN04R040B-VB Datasheet N-Channel 40-V (D-S) MOSFET

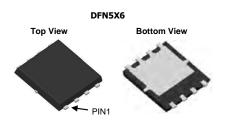
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
40	0.0025 at V _{GS} = 10 V	120	38 nC		
	0.0028 at V _{GS} = 6.5 V	105	30 110		

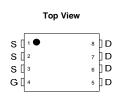
FEATURES

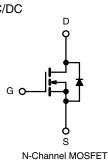
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested •
- 100 % UIS Tested •

APPLICATIONS

- Synchronous Rectification
- Secondary Side DC/DC







Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40	v	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$	I _D	120 80 33 ^{b, c}		
Pulsed Drain Current		I _{DM}	26 ^{b, c} 360	— A	
Continuous Source-Drain Diode Current	T _C = 25 °C T _A = 25 °C	I _S	100 4.9 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	40		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	80	mJ	
Maximum Power Dissipation	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	P _D	83 53 5.4 ^{b, c} 3.4 ^{b, c}	w	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		
Soldering Recommendations (Peak Temperatur		260			

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	18	23	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.0	1.5	0/11		

Notes:

a. Based on T_C = 25 °C.
b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 90 °C/W.

e. Calculated based on maximum junction temperature. Package limitation current is 80 A.

Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
			, ,,			
V _{DS}	V _{GS} = 0 V, I _D = 250 μA	40			V	
∆V _{DS} /T _J	VGS - 0 V, ID - 200 p. (40	13		mV/°C	
	I _D = 250 μA					
. ,		0.0	- 0	4.0		
-		2.0			V	
IGSS					nA	
I _{DSS}					μA	
				10	<u> </u>	
I _{D(on)}		100			A	
R _{DS(op)}			0.0025		Ω	
D0(01)			0.0028			
9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$		102		S	
C _{iss}			4750		pF	
C _{oss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz		610			
C _{rss}			275			
	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		78	117	nC	
Qg			38	57		
Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		13			
Q _{gd}			11			
R _g	f = 1 MHz	0.2	0.7	1.4	Ω	
_			14	25		
	$V_{DD} = 20 V, R_1 = 2 \Omega$		9	18	ns	
	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		41	65		
			9	18		
			33	42		
	$V_{DD} = 20 \text{ V. } \text{R}_1 = 2 \Omega$		22	35		
	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_a = 1 \Omega$		42	65		
	9					
				_•	1	
ا _S	T _C = 25 °C		50		А	
I _{SM}			60			
-	I _S = 5 A			1.1	V	
	<u> </u>				ns	
					nC	
	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$					
					ns	
	$\begin{array}{c} \Delta V_{\rm GS(th)}/T_{\rm J}\\ V_{\rm GS(th)}\\ I_{\rm GSS}\\ I_{\rm DSS}\\ I_{\rm DSS}\\ I_{\rm D(on)}\\ {} \\ R_{\rm DS(on)}\\ g_{\rm fs}\\ \hline\\ C_{\rm iss}\\ C_{\rm oss}\\ C_{\rm rss}\\ C_{\rm oss}\\ C_{\rm rss}\\ Q_{\rm g}\\ Q_{\rm gd}\\ R_{\rm g}\\ I_{\rm d(on)}\\ I_{\rm r}\\ I_{\rm d(off)}\\ I_{\rm f}\\ I_{\rm d(off)}\\ I_{\rm f}\\ I_{\rm d(off)}\\ I_{\rm f}\\ I_{\rm d(off)}\\ I_{\rm f}\\ I_{\rm f}\\ I_{\rm d(off)}\\ I_{\rm f}\\ I_{\rm f}\\ I_{\rm f}\\ I_{\rm d(off)}\\ I_{\rm f}\\ I_{\rm f$	$\begin{array}{ c c c c } I_{D} = 250 \ \mu A \\ I_{D} = 250 \ \mu A \\ \hline I_{D} = 250 \ \mu A \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_{D} = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_{J} = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} \ge 40 \ V, \ V_{GS} = 0 \ V, \ T_{J} = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_{J} = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 5 \ V, \ I_{D} = 20 \ A \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 20 \ V, \ V_{GS} = 10 \ V, \ I_{D} = 20 \ A \\ \hline Q_{gd} & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_{D} = 20 \ A \\ \hline Q_{gd} & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_{D} = 20 \ A \\ \hline Q_{gd} & I_{D} \cong 10 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(on) & V_{DD} = 20 \ V, \ R_{L} = 2 \ \Omega \\ \hline I_{D} \cong 10 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{D} \cong 10 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline T_{d}(off) & I_{F} = 10 \ A, \ V_{dEN} = 5 \ A \\ \hline T_{d}(a) & I_{F} = 10 \ A, \ U_{d}(a) \ I_{S} = 5 \ A \\ \hline T_{d}(a) & I_{F} = 10 \ A, \ U_{d}(a) \ I_{D} = 25 \ ^{\circ}C \\ \hline \hline I_{S} & I_{S} \ F \ A \\ \hline T_{d}(a) & I_{S} = 5 \ A \\ \hline T_{d}(a) & I_{S} = 5 \ A \\ \hline T_{d}(a) & I_{S} = 5 \ A \\ \hline T_{d}(a) & I_{S} = 5 \ A \\ \hline T_{d}(a) & I_{S} \ F \ A \\ \hline T_{d}(a) & I_{S} \ F \ A \\ \hline T_{d}(a) & I_{S} \ A \ A \\ \hline T_{d}(a) & I_{S} \ A \ A \\ \hline T_{d}(a) & I_{S} \ A \ A \\ \hline T_{d}(a) & I_{S} \ A \ A \ A \ A \ A \ $	$\begin{array}{ c c c c c }\hline H_{D} = 250 \ \mu A & \hline \\ \hline H_{D} = 250 \ \mu A & \hline \\ \hline$	$ \begin{array}{ c c c c c c } & I_{D} = 250 \ \mu A & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Notes:

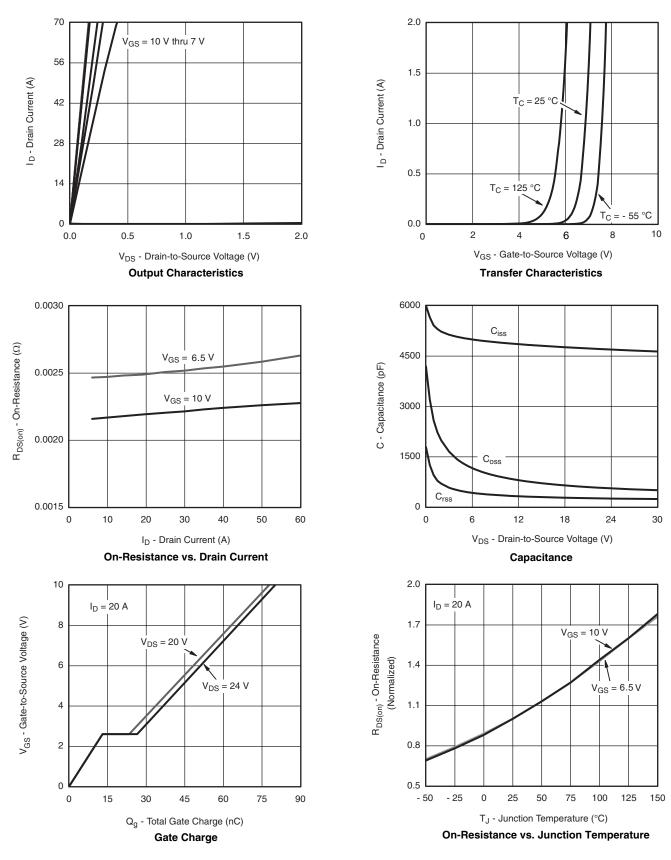
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

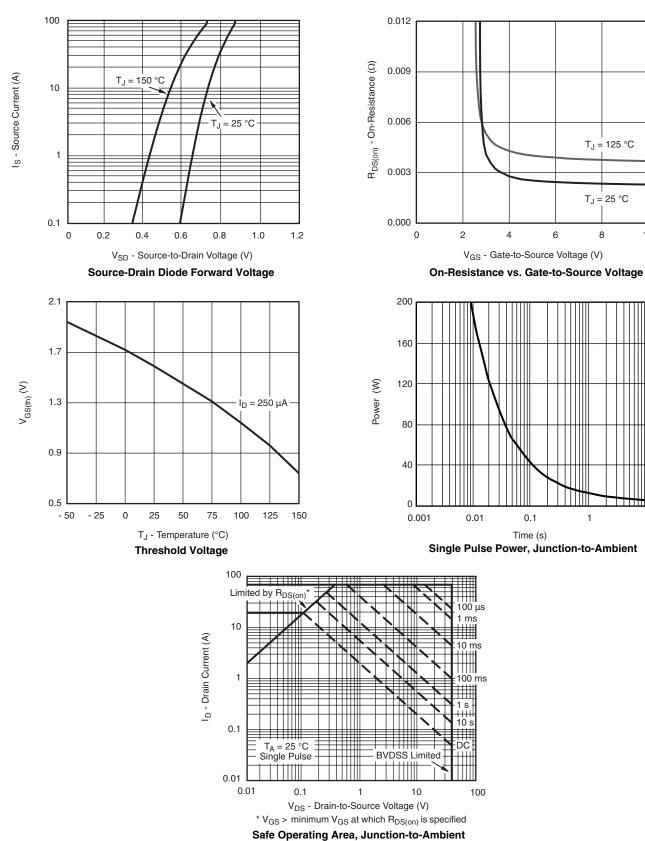


服务热线:400-655-8788



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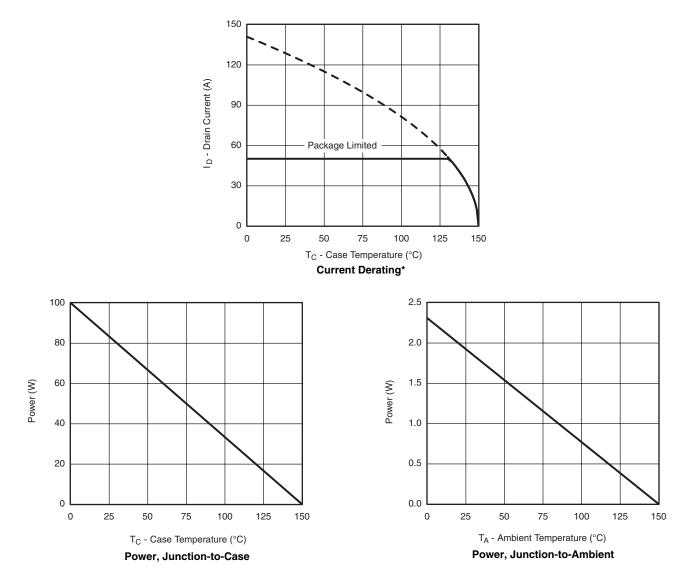
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



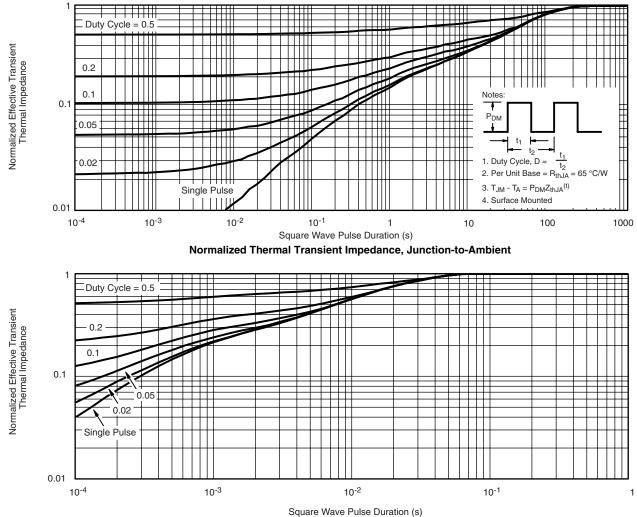
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

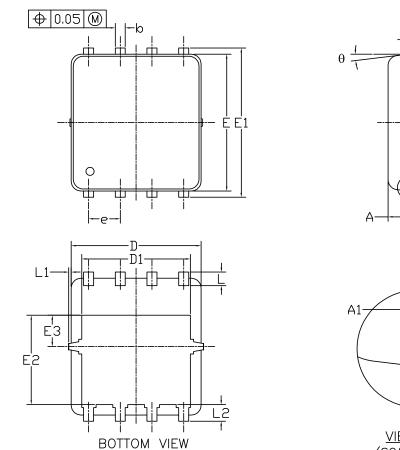


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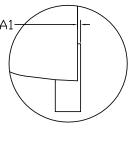


Normalized Thermal Transient Impedance, Junction-to-Case





DFN5x6_8L_EP1_P PACKAGE OUTLIN

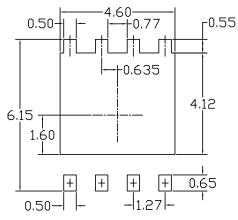


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VIEW 'A'

<u>VIEW 'A'</u> (SCALE 5:1)

RECOMMENDED LAND PATTERN



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
SIMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
А	0.85	0.95	1.00	0.033	0.037	0.039
A1	0.00		0.05	0.000		0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
с	0.15	0.20	0.25	0.006	0.008	0.010
D	5.10	5.20	5.30	0.201	0.205	0.209
D1	4.25	4.35	4.45	0.167	0.171	0.175
Е	5.45	5.55	5.65	0.215	0.219	0.222
E1	5.95	6.05	6.15	0.234	0.238	0.242
E2	3.525	3.625	3.725	0.139	0.143	0.147
E3	1.175	1.275	1.375	0.046	0.050	0.054
e	1.27 BSC			0.050 BSC		
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0		0.15	0		0.006
L2	0.68 REF			0.027 REF		
θ	0°		10°	0°		10°

NOTE

 PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
 CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

UNIT: mm



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